



Product Change Notification

Change Notification #: 114661-00
Change Title: Intel® Server Chassis H2216XXKR2,
Intel® Server Chassis H2312XXKR2
PCN114661-00, Label
Regulatory and Safety Label Update

Date of Publication: May 31, 2016

Key Characteristics of the Change:
Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material *:	June 15, 2016
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing next changes on the Intel® Server Chassis H2216XXKR2 and the Intel® Server Chassis H2312XXKR2.

1. Update the packaging regulatory label. RCM Mark and Safety Nemko logo update. See Figure 1 and Figure 2 for your reference:



Figure 1 Pre Change Label



Figure 2 Post Change Label

- Update the system regulatory label. RCM Mark and Safety Nemko logo update. See Figure 3 and Figure 4 for your reference:



Figure 4 Pre Change Label



Figure 3 Post Change Label

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the changes and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
H2216XXKR2	933688	H20866-005	H13900-450	H20866-006	H13900-450
H2312XXKR2	933689	H20865-005	G92718-250	H20865-006	G92718-250

PCN Revision History:

Date of Revision:

May 31, 2016

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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